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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
PATENT APPLICATION

In re Application of:

Venkateswaran

Serial No.: 10/789,646

Filed: 03/01/2004

Atty. Docket: TI-34105.1

Art Unit: 2813

Examiner: J. Dolan

For: SEMICONDUCTOR DEVICE PACKAGE AND METHOD OF MAKING THE  
SAME

*Replacement  
Drawings  
Approved - GMD  
1/5/06*

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING 37 CFR §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on the date indicated below.

*10-5-2005*

*Jackie McBride*  
Jackie McBride

LETTER TO THE OFFICIAL DRAFTSPERSON

Sir:

Please find enclosed eight (8) sheets of replacement formal drawings in the patent application referenced above.

Respectfully submitted,

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